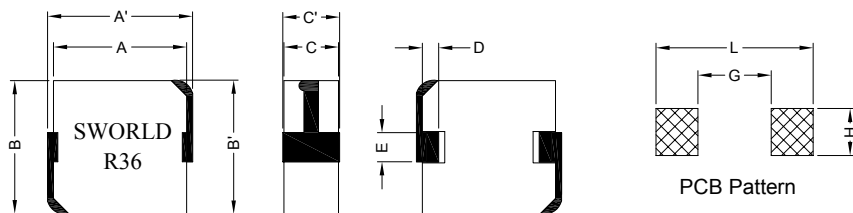


1. PART NO. EXPRESSION :

L 8 1 1 H W - 1 R 0 M F - □ □
 (a) (b) (c) (d)(e) (f)

- (a) Series code
- (b) Type code
- (c) Inductance code : 1R0 = 1.0uH
- (d) Tolerance code : M = ±20%
- (e) F : RoHS Compliant
- (f) 11 ~ 99 : Internal controlled number

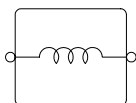
2. CONFIGURATION & DIMENSIONS :



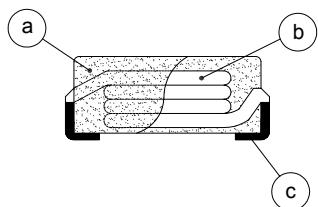
Unit:m/m

| A' | A | B' | B | C' | C | D | E | G | H | L |
|-----------|----------|-----------|----------|----------|----------|---------|---------|----------|----------|-----------|
| 11.8 Max. | 10.2±0.5 | 10.5 Max. | 10.0±0.5 | 4.2 Max. | 4.0 Max. | 2.2±0.5 | 2.9±0.5 | 5.4 Ref. | 4.5 Ref. | 12.4 Ref. |

3. SCHEMATIC :



4. MATERIALS :



- (a) Core
- (b) Wire
- (c) Terminal

5. FEATURES :

- a) Shielded Construction
- b) Frequency up to 5MHz



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30.08.2010



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6. GENERAL SPECIFICATION :

- a) Test Freq. : 100KHz/1.0VDC; Q : 100KHz/1.0VDC
- b) Ambient Temp. : 20°C
- c) Operating Temp. : -55°C to +125°C
- d) Storage Temp. : -55°C to +125°C
- e) Humidity Range : 50 ~ 60% RH
- f) Heat Rated Current (I_{rms}) : Will cause the coil temp. rise approximately $\Delta T=40^{\circ}C$ without core loss.
- g) Saturation Current (I_{sat}) : Will cause L_o to drop approximately 20% typ.
- h) Part Temperature (Ambient+Temp. Rise) : Should not exceed 125°C under worst case operating conditions.

7. ELECTRICAL CHARACTERISTICS :

| Part No. | Inductance L _o (μH) $\pm 20\%$ @ 0 Adc | I _{rms} (A) Typ. | I _{sat} (A) Typ. | DCR (m Ω) Max. | Q Min. |
|-----------------|--|-----------------------------------|-----------------------------------|-------------------------------|-----------|
| L811HW-R22MF-□□ | 0.22 | 32 | 40 | 1.4 | 18 |
| L811HW-R36MF-□□ | 0.36 | 28 | 40 | 1.4 | 18 |
| L811HW-R47MF-□□ | 0.47 | 26 | 38 | 1.6 | 18 |
| L811HW-R56MF-□□ | 0.56 | 25 | 36 | 1.9 | 18 |
| L811HW-R68MF-□□ | 0.68 | 23 | 32 | 2.4 | 18 |
| L811HW-1R0MF-□□ | 1.00 | 20 | 28 | 3.5 | 20 |
| L811HW-1R5MF-□□ | 1.50 | 12 | 20 | 7.5 | 20 |
| L811HW-2R2MF-□□ | 2.20 | 11.5 | 16.5 | 8.56 | 20 |
| L811HW-3R3MF-□□ | 3.30 | 10.0 | 14 | 10.0 | 20 |
| L811HW-4R7MF-□□ | 4.70 | 8.0 | 13 | 13.5 | 20 |
| L811HW-6R8MF-□□ | 6.80 | 6.5 | 11 | 24.0 | 20 |
| L811HW-100MF-□□ | 10.00 | 5.0 | 9 | 35.0 | 20 |



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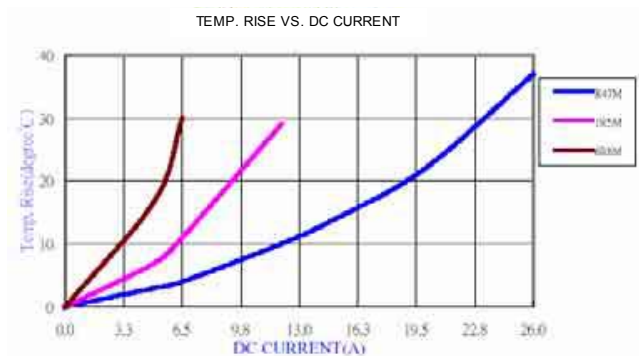
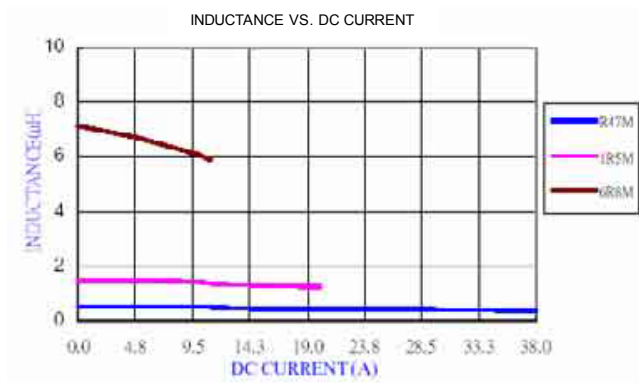
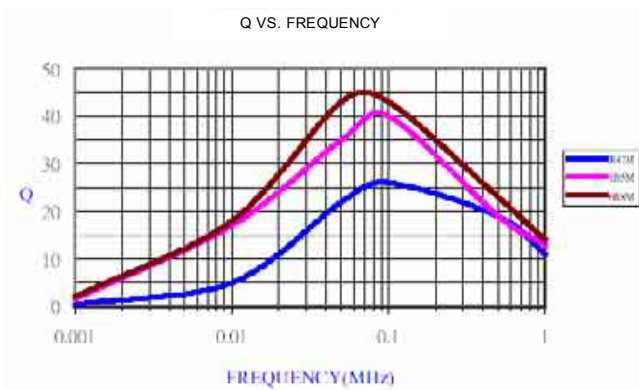
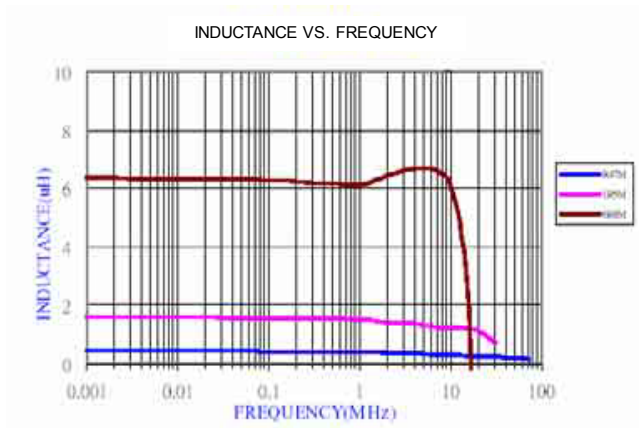
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8. CHARACTERISTICS CURVES :



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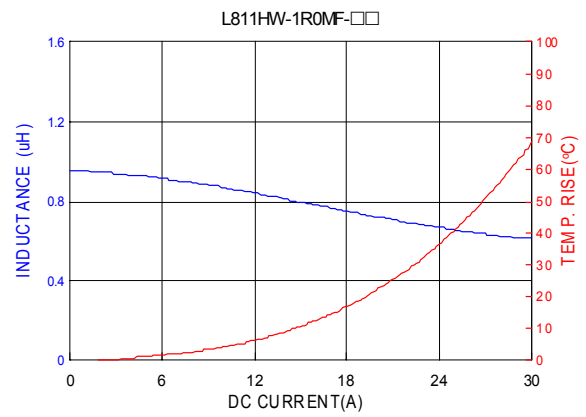
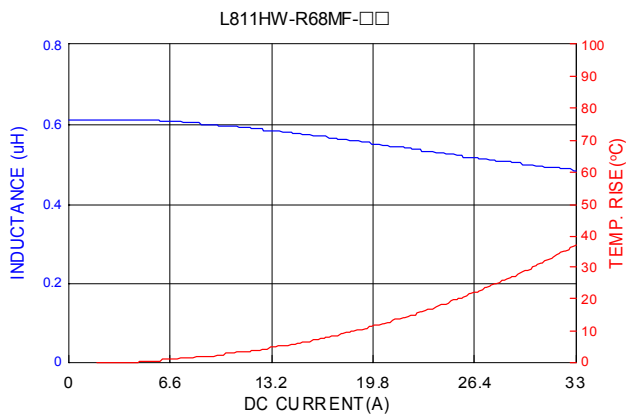
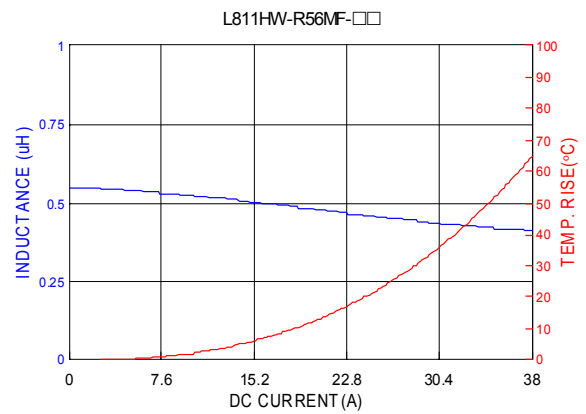
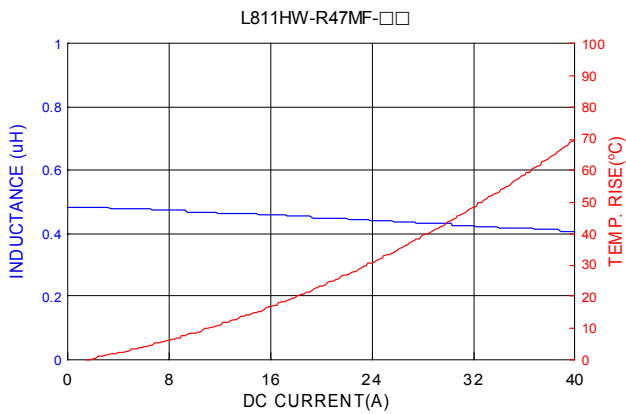
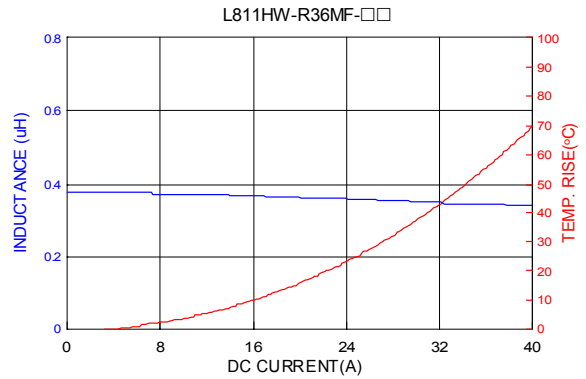
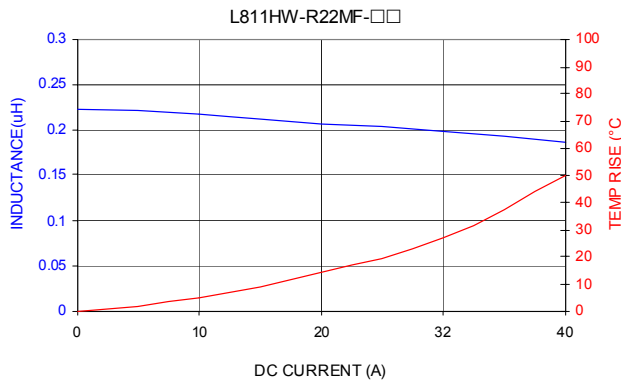
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8. CHARACTERISTICS CURVES :



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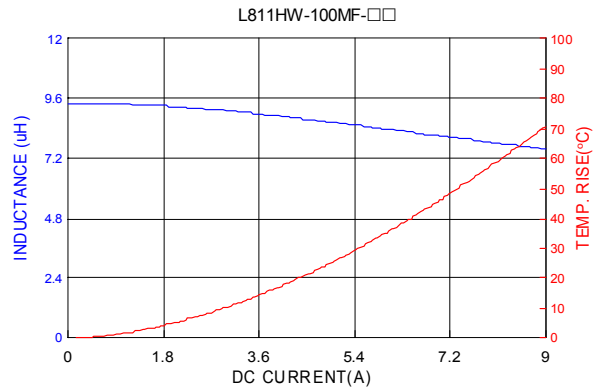
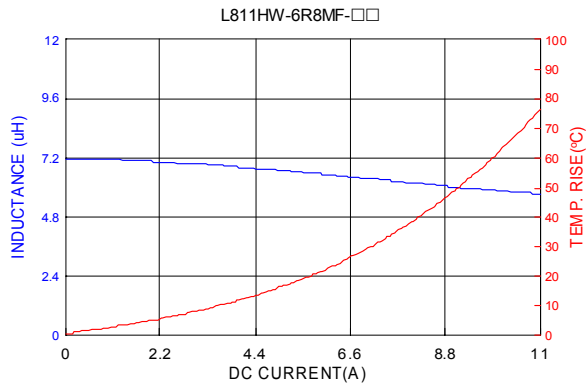
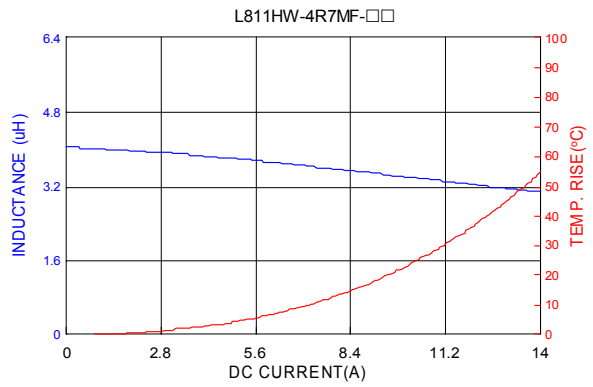
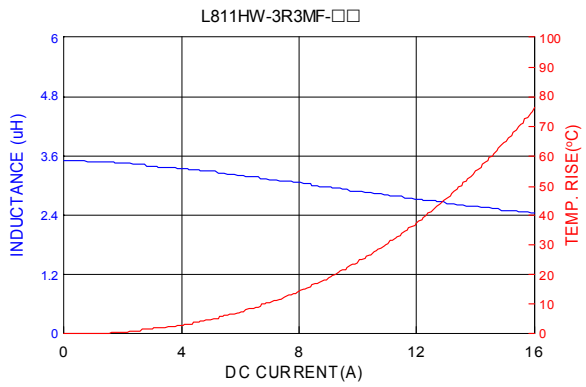
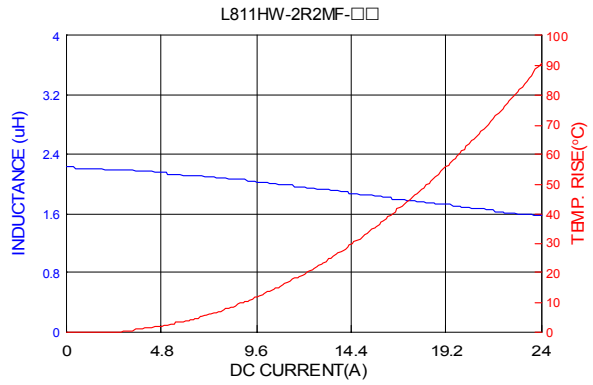
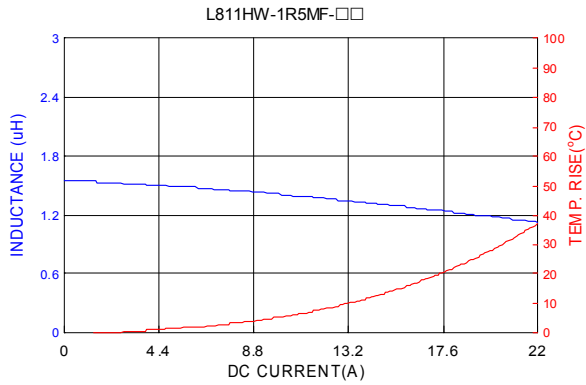
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8. CHARACTERISTICS CURVES :



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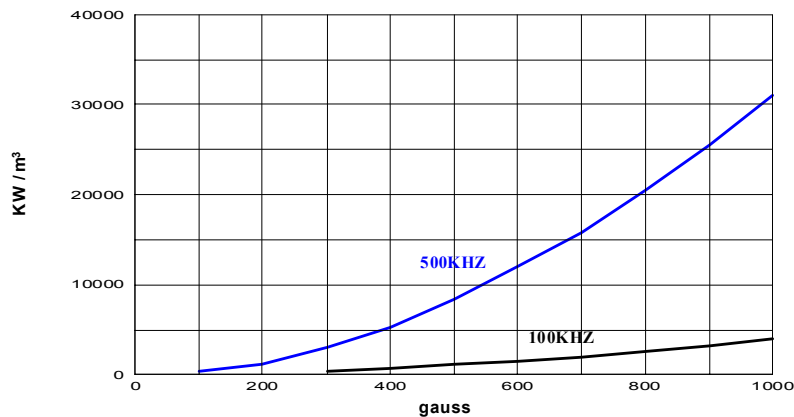
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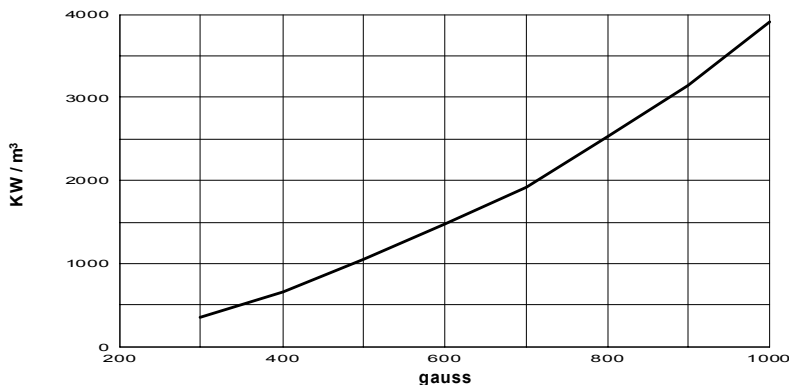
9. CORE LOSS :

100KHz and 500KHz



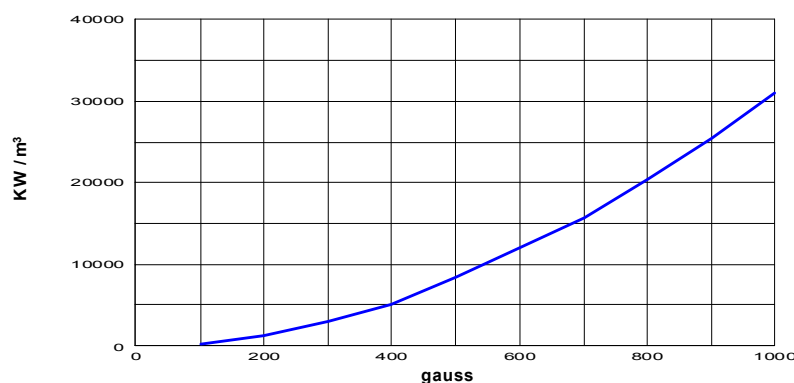
| material gauss \ loss | 100KHz | 500KHz |
|--------------------------|--------|--------|
| 100 | - | 266 |
| 200 | - | 1,234 |
| 300 | 351.7 | 2,932 |
| 400 | 665.9 | 5,195 |
| 500 | 1,039 | 8,336 |
| 600 | 1,471 | 12,025 |
| 700 | 1,923 | 15,715 |
| 800 | 2,537 | 20,444 |
| 900 | 3,148 | 25,429 |
| 1000 | 3,902 | 31,002 |

100KHz



| material gauss \ loss | 100KHz |
|--------------------------|--------|
| 300 | 351.7 |
| 400 | 665.9 |
| 500 | 1,039 |
| 600 | 1,471 |
| 700 | 1,923 |
| 800 | 2,537 |
| 900 | 3,148 |
| 1000 | 3,902 |

500KHz



| material gauss \ loss | 500KHz |
|--------------------------|--------|
| 100 | 266 |
| 200 | 1,234 |
| 300 | 2,932 |
| 400 | 5,195 |
| 500 | 8,336 |
| 600 | 12,025 |
| 700 | 15,715 |
| 800 | 20,444 |
| 900 | 25,429 |
| 1000 | 31,002 |



RoHS Compliant

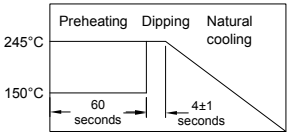
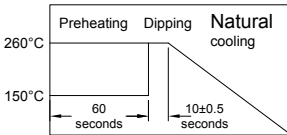
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10. RELIABILITY AND TEST CONDITION :

| ITEM | PERFORMANCE | TEST CONDITION | | | | | | | | | | | | | | |
|--|--|--|------|------------------|--------------|---|-------|------|---|------------------|----------|---|--------|------|---|------------------|
| Electrical Characteristics Test | | | | | | | | | | | | | | | | |
| Inductance | Refer to standard electrical characteristics list | HP4284A, CH11025, CH3302, CH1320, CH1320S LCR meter. | | | | | | | | | | | | | | |
| DCR | | CH16502, Agilent33420A Micro-Ohm Meter. | | | | | | | | | | | | | | |
| Heat Rated Current (I _{rms}) | | I _{rms} (A) will cause the coil temperature rise approximately $\Delta T=40^{\circ}\text{C}$ without core loss 1. Applied the allowed DC current 2. Temperature measured by digital surface thermometer | | | | | | | | | | | | | | |
| Saturation Current (I _{sat}) | | I _{sat} (A) will cause L _o to drop approximately 20% typ. | | | | | | | | | | | | | | |
| Mechanical Performance Test | | | | | | | | | | | | | | | | |
| Solderability Test | More than 90% of the terminal electrode should be covered with solder.  | Preheat : 150°C, 60sec. Solder : Sn99.95-Cu0.05 Solder Temperature : 245±5°C Flux for lead free : rosin Dip Time : 4±1sec. | | | | | | | | | | | | | | |
| Solder Heat Resistance | 1. Appearance : No significant abnormality 2. Inductance change : Within ±20%  | Preheat : 150°C, 60sec. Solder : Sn99.95-Cu0.05 Solder Temperature : 260±5°C Flux for lead free : rosin Dip Time : 10±0.5sec. | | | | | | | | | | | | | | |
| Reliability Test | | | | | | | | | | | | | | | | |
| High Temperature Life Test | 1. Appearance : No damage 2. Inductance : Within ±20% of initial value. No disconnection or short circuit. | Temperature : 125±5°C Time : 500±12 hours Measure at room temperature after placing for 2 to 3 hrs. | | | | | | | | | | | | | | |
| Low Temperature Life Test | | Temperature : -55±5°C Time : 500±12 hours Measure at room temperature after placing for 2 to 3 hrs. | | | | | | | | | | | | | | |
| Thermal Shock | | Conditions of 1 cycle. <table border="1" data-bbox="933 1391 1299 1525"> <thead> <tr> <th>Step</th> <th>Temperature (°C)</th> <th>Times (min.)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>-55±3</td> <td>30±3</td> </tr> <tr> <td>2</td> <td>Room Temperature</td> <td>Within 3</td> </tr> <tr> <td>3</td> <td>+125±3</td> <td>30±3</td> </tr> <tr> <td>4</td> <td>Room Temperature</td> <td>Within 3</td> </tr> </tbody> </table> Total : 5 cycles Measure at room temperature after placing for 2 to 3 hrs. | Step | Temperature (°C) | Times (min.) | 1 | -55±3 | 30±3 | 2 | Room Temperature | Within 3 | 3 | +125±3 | 30±3 | 4 | Room Temperature |
| Step | Temperature (°C) | Times (min.) | | | | | | | | | | | | | | |
| 1 | -55±3 | 30±3 | | | | | | | | | | | | | | |
| 2 | Room Temperature | Within 3 | | | | | | | | | | | | | | |
| 3 | +125±3 | 30±3 | | | | | | | | | | | | | | |
| 4 | Room Temperature | Within 3 | | | | | | | | | | | | | | |
| Humidity Resistance | 1. Appearance : No damage 2. Inductance : Within ±20% of initial value. No disconnection or short circuit. | Temperature : 40±5°C Humidity : 90% to 95% Applied Current : Rated Current Time : 500±12 hours Measure at room temperature after placing for 2 to 3 hrs. | | | | | | | | | | | | | | |
| Random Vibration Test | Appearance : Cracking, shipping and any other defects harmful to the characteristics should not be allowed. | Frequency : 10-55-10Hz for 1 min. Amplitude : 1.52mm Directions & times : X, Y, Z directions for 2 hours. A period of 2 hours in each of 3 mutually perpendicular directions (Total 6 hours). | | | | | | | | | | | | | | |

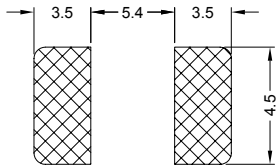
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30.08.2010



11. SOLDERING AND MOUNTING :

11-1. Recommended PC Board Pattern



11-2. Soldering

Mildly activated rosin fluxes are preferred. The minimum amount of solder can lead to damage from the stresses caused by the difference in coefficients of expansion between solder, chip and substrate. Our terminations are suitable for all wave and re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

11-2.1 Solder Re-flow :

Recommended temperature profiles for re-flow soldering in Figure 1.

11-2.2 Soldering Iron (Figure 2) :

Products attachment with soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

Note :

- Preheat circuit and products to 150°C.
- 280°C tip temperature (max)
- Never contact the ceramic with the iron tip
- 1.0mm tip diameter (max)
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- Limit soldering time to 3 secs.

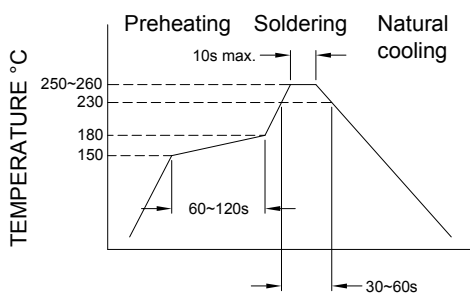


Figure 1. Re-flow Soldering

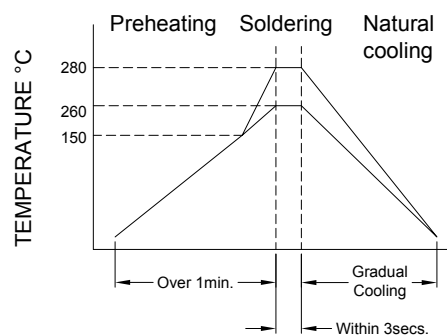


Figure 2. Iron Soldering



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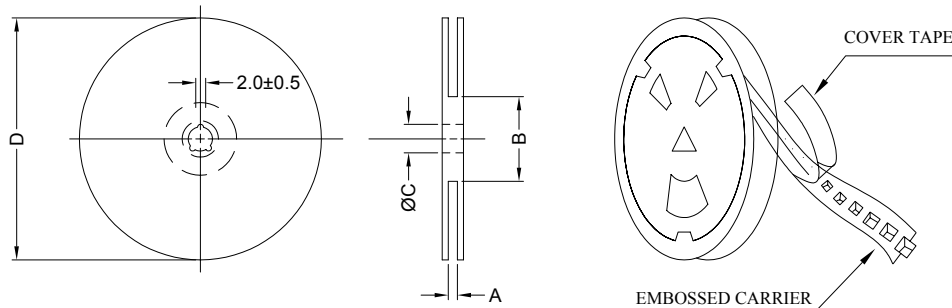
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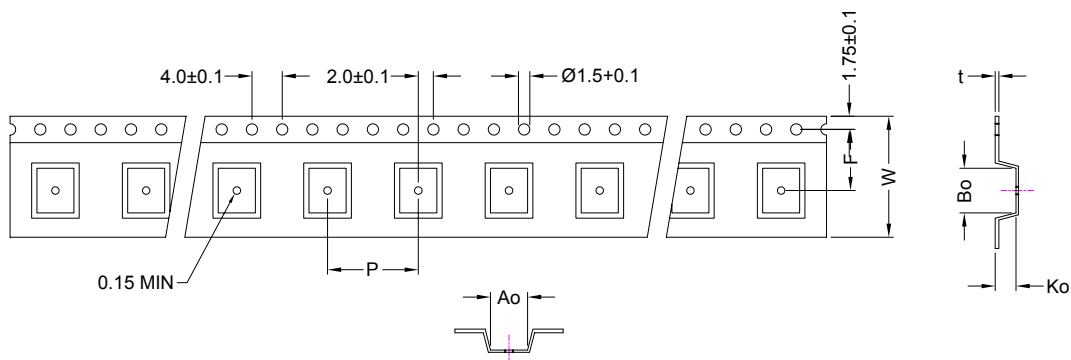
12. PACKAGING INFORMATION :

12-1. Reel Dimension



| Type | A(mm) | B(mm) | C(mm) | D(mm) |
|------------|----------|---------|----------|-------|
| 13" x 24mm | 24.0±0.5 | 100±2.0 | 13.5±0.5 | 330 |

12-2 Tape Dimension



| Series | Ao(mm) | Bo(mm) | Ko(mm) | P(mm) | W(mm) | F(mm) | t(mm) |
|--------|----------|----------|---------|----------|----------|----------|-----------|
| L811HW | 10.5±0.1 | 11.8±0.1 | 4.5±0.1 | 16.0±0.1 | 24.0±0.3 | 11.5±0.1 | 0.35±0.05 |

12-3. Packaging Quantity

| Size | L811HW |
|-------------|--------|
| Chip / Reel | 900 |
| Inner Box | 1800 |
| Carton | 7200 |

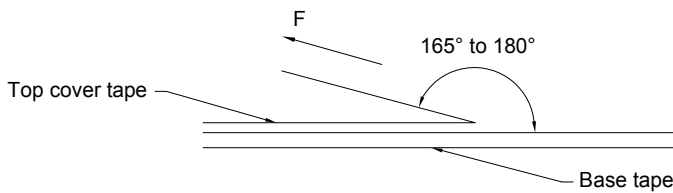


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12-4. Tearing Off Force



The force for tearing off cover tape is 15 to 60 grams in the arrow direction under the following conditions.

| Room Temp. (°C) | Room Humidity (%) | Room atm (hPa) | Tearing Speed (mm/min) |
|-----------------|-------------------|----------------|------------------------|
| 5~35 | 45~85 | 860~1060 | 300 |

Application Notice

1. Storage Conditions :

To maintain the solderability of terminal electrodes :

- a) Temperature and humidity conditions : Less than 30°C and 70% RH.
- b) Recommended products should be used within 6 months from the time of delivery.
- c) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation :

- a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- b) The use of tweezers or vacuum pick up is strongly recommended for individual components.
- c) Bulk handling should ensure that abrasion and mechanical shock are minimized.



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PG. 10